



CUSTOMER DRAWING ONLY

OPTION	CONNECTOR			PCB LAYOUT			RAM BOARD		
	Р	0ST	TYPE	VOLTAGE	HOLE	HOLE		VOLTAGE	DRAM/SDRAM
P/N	METAL	LOCATION	MARKING	MARKING	LOCATION	DIA.(mm	n)	KEYING	KEYING
1100-01	METAL	BCD	DRAM	5.0V	BCD			(DIM. A) 4.175	(DIM. B) 3.175
1100-02	METAL	BCD	DRAM	3.3V	BCD	_			
1100-03	METAL	A D	DRAM	5.0V	(A) (D)	-		2.00	2.00
1100-04	METAL	A D	DRAM	3.3V	(A) (D)			<u>5.0V</u>	
1100-05	METAL	BC	DRAM	5.0V	BC	2.44+_ 0.05	,	(DIM. A) 80 50 50 50 50 50 50 50 50 50 50 50 50 50	4.175 000 000 000 000 000 000 000 000 000 0
1100-06	METAL		DRAM	3.3V	A C D	Z.44T_ 0.	,00		
1100-07	METAL	ACD	SDRAM	5.0V	A C D			2.00 - 3.3V	2.00
1100-08	METAL	A C D	SDRAM	3.3V	ACD				(DIM. B) 8
1100-09	METAL	A C D	UNBUFFERED DRAM	5.0V	ACD				2.175
1100-10	METAL	ACD	UNBUFFERED DRAM	3.3V	A C D				
1100-11	METAL	BCD	UNBUFFERED DRAM	3.3V	BCD				2.00 NBUFFERED DRAM
Drawn By: LJ, H	Checked By: PFR Material: High Temp Thermoplastic						Chupond America 6168 Greenhill Road, New Hope, PA 18938-9630 USA		
Drawn: 2/26/96	Scale: None		Plating: Flash Au				TIT	TLE: DIMM	168 POSITIONS
Released: 2/26/96	: Sheet 3 of 4		Tolerances: ± 0.005"; ± 0.01"; and ±2°				EN	NG. #: 1100-0	00000 Rev.

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